

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

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Title of
Invention

MULTI-RUN SELECTIVE PATTERN AND ETCH WAFER
PROCESS

Application Number:

Confirmation Number:

First Named Applicant: Kenneth Bandy

Attorney Docket Number: BUR920020075US1

Search string: (6245581 or 6232134 or 5980766 or 5790254 or 5629772).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	6245581	2001-06-12	Bonser et al.		438	8
	2	6232134	2001-05-15	Farber et al.		438	9
	3	5980766	1999-11-09	Flamm et all.		216	59
	4	5790254	1998-08-04	Ausschnitt		356	372
	5	5629772	1997-05-13	Ausschnitt		256	372

Signature

Examiner Name	Date